# Yaotian Liu

yaotian\_liu@asu.edu | github.com/ytliu74 | scholar.google | LinkedIn

#### **Education**

#### Arizona State University

2023/08 - 2028/06 (Expected)

PhD in Computer Engineering

Tempe, Arizona, US

• GPA: 4.0/4.0

#### Shanghai Jiao Tong University

2019/09 - 2023/06

Bachelor of Engineering in Microelectronics Science and Engineering

Shanghai, China

- GPA: 3.7/4.3. Rank 19/67.
- Outstanding Graduates

# **Work Experience**

### Shanghai Taize Semiconductor

2022/06 - 2022/09, 2023/03 - 2023/06

Digital IC Design Intern

Shanghai, China

- Developed the micro-architecture for the data link layer of the company's proprietary inter-chip connection, supporting 1024 chips. Co-author of a related patent. The design has been successfully taped out using TSMC 16 nm.
- Developed an accelerator for elliptic curve accumulation in Elliptic Curve Cryptography (ECC).

# Research Experience

#### Arizona State University, ECEE

2023/08 - Now

Research Assistant, advised by Prof. Jeff Zhang

Tempe, AZ, US

- Skip-SCAR: Hardware-Friendly High-Quality Embodied Visual Navigation, in submission to ICRA 2025.
  - ► The first computation-efficient ObjectNav system features a skip mechanism and a novel SCAR-based predictor that leverage sparsity to significantly reduce memory usage.
  - Currently No.1 among all published methods in the online leaderboard.

#### • Intel 16nm Tapeout

- ▶ Designed, implemented and verified a systolic array with AXI interfaces in SystemC.
- Designed, implemented and verified a RISC-V & AXI based SoC design in SystemVerilog, which supports arbitrary number of accerlerators and memories.
- ► Developed an agile physical design flow using Synopsys Fusion Compiler.
- Setup multiple automatic scripts to speed up relative flows.
  - A flow to transfer memory IPs from SystemVerilog to Verilog and then generate a Catapult memory library by automatically extracting relevant information from the Verilog code and datasheet.
  - An automatic Docker-based RISC-V cross-compilation flow, able to run on any type of host machine.
  - A flow to run CVA6 (a RISC-V code) simulation with Verilator to generate waveform.

## LLM-VeriPPA

• Developed a Python workflow to automatically extract information from Verilog code, perform logic synthesis for PPA (Power, Performance, and Area), and iteratively reduce the clock period to find the fastest possible timing.

## Shanghai Jiao Tong University, Department of Micro/Nano Electronics

2023/01 - 2023/05

Final Year Project, advised by Prof. Yongfu Li

Shanghai, China

- Implemented a functional ECO system with a Verilg parser written in PEG grammar, accepted by AICAS 2023.
- An ABC-based algorithm for efficient circuit pruning by removing functionally equivalent sub-circuits, which increase the performance of functional ECO.

# Shanghai Jiao Tong University, AI Institute

2022/05 - 2022/09

Undergraduate Research Assistant, advised by Prof. Yunbo Wang

Shanghai, China

- Implemented a reinforcement learning algorithm for automatically stock trading.
- Reproduced an baseline algorithm <u>ytliu/FactorVAE</u> (57 stars) from AAAI 2022.

#### **Publications**

• <u>Liu, Y.</u>, Cao, Y., Zhang, J., "Skip-SCAR: Hardware-Friendly High-Quality Embodied Visual Navigation." <u>arXiv preprint</u> <u>arXiv: 2405.14154</u>, in submission to ICRA 2025.

*Update time:* 2024-12-12

- Nalla, P., Haque, E., <u>Liu, Y.</u>, Sapatnekar S., Zhang, J., Chakrabarti, C., Cao, Y., "CLAIRE: Composable Chiplet Libraries for AI Inference" 2025 Design Automation and Test in Europe Conference (DATE)
- Wang, Z., Sun, J., Goksoy, A., Mandal, S., <u>Liu, Y.</u>, Seo, J., etc. "Exploiting 2.5D/3D Heterogeneous Integration for AI Computing," 2024 29th Asia and South Pacific Design Automation Conference (ASP-DAC)
- Thorat, K., Zhao, J., <u>Liu, Y.</u>, Peng, H., Xie, X., Lei, B., Zhang, J. and Ding, C.. "Advanced Language Model-Driven Verilog Development: Enhancing Power, Performance, and Area Optimization in Code Synthesis." *arXiv preprint arXiv:2312.01022*.
- <u>Liu, Y.</u>, Zhang, Y., Zhang, Q., Chen, R. and Li, Y., 2023, June. "FEEP: Functional ECO synthesis with efficient patch minimization." In 2023 *IEEE 5th International Conference on Artificial Intelligence Circuits and Systems (AICAS)*.

# **Open-Sourse Project**

## obsidian-pseudocode <u>vtliu74/obsidian-pseudocode</u> (91 stars)

• An Obsidian plugin that renders LaTeX-style pseudocode in a code block, offering various auxiliary features.

# simple SPICE <a href="mailto:ytliu74/SimpleEDA">ytliu74/SimpleEDA</a> (7 stars)

• A basic SPICE tool for circuit simulation supports DC, AC, and TRAN analysis for linear and nonlinear devices with a GTK interface.

#### **Skills**

**Programming Languages:** Verilog, Python, C/C++, Javascript/Typescript.

Tech Skills: Git, Digital Logic Design, Pytorch, Linux, Docker, Matlab, RTL to GDSII flow...

*Update time:* 2024-12-12